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XP151A11B0MR-G

Power MOSFET

■GENERAL DESCRIPTION

The XP151A11B0MR-G is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics.

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

In order to counter static, a gate protect diode is built-in.

The small SOT-23 package makes high density mounting possible.

■ APPLICATIONS

- Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

■FEATURES

Low On-State Resistance : Rds(on) = 0.12 Ω@ Vgs = 10V : Rds(on) = 0.17 Ω@ Vgs = 4.5V Ultra High-Speed Switching Gate Protect Diode Built-in Driving Voltage : 4.5V N-Channel Power MOSFET DMOS Structure Small Package : SOT-23 Environmentally Friendly : EU RoHS Compliant, Pb Free

PRODUCT NAMES

PRODUCTS	PACKAGE	ORDER UNIT
XP151A11B0MR	SOT-23	3,000/Reel
XP151A11B0MR-G ^(*)	SOT-23	3,000/Reel

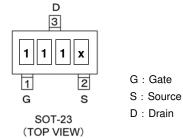
⁽¹⁾ The "-G" suffix denotes Halogen and Antimony free as well as being fully RoHS compliant.

■ABSOLUTE MAXIMUM RATINGS

		Та	= 25°C
PARAMETER	SYMBOL	RATINGS	UNITS
Drain - Source Voltage	Vdss	30	V
Gate - Source Voltage	Vgss	±20	V
Drain Current (DC)	ld	1	А
Drain Current (Pulse)	ldp	4	А
Reverse Drain Current	ldr	1	А
Channel Power Dissipation *	Pd	0.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55~150	°C

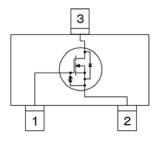
* When implemented on a ceramic PCB

■ PIN CONFIGURATION/ MARKING



* x represents production lot number.

■EQUIVALENT CIRCUIT



N-channel MOSFET (1 device built-in)

■ELECTRICAL CHARACTERISTICS

DC Characteristics

DC Characteristics					Т	a = 25°C
PARAMETER	SYMBOL CONDITIONS		MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds= 30V, Vgs= 0V	-	-	10	μA
Gate-Source Leak Current	lgss	Vgs= $\pm 20V$, Vds= 0V	-	-	±10	μA
Gate-Source Cut-Off Voltage	Vgs(off)	Id= 1mA, Vds= 10V	1.0	-	3.0	V
Drain-Source On-State Resistance *1	Rds(on)	ld= 0.5A, Vgs= 10V	-	0.09	0.12	Ω
		ld= 0.5A, Vgs= 4.5V	-	0.13	0.17	Ω
Forward Transfer Admittance *1	Yfs	ld= 0.5A, Vds= 10V	-	2.4	-	S
Body Drain Diode Forward Voltage	Vf	lf= 1A, Vgs= 0V	-	0.8	1.1	V

*1 Effective during pulse test.

Dynamic Characteristics

,						a = 250
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss		-	150	-	pF
Output Capacitance	Coss	Vds= 10V, Vgs=0V f=1MHz	-	90	-	pF
Feedback Capacitance	Crss		-	30	-	pF

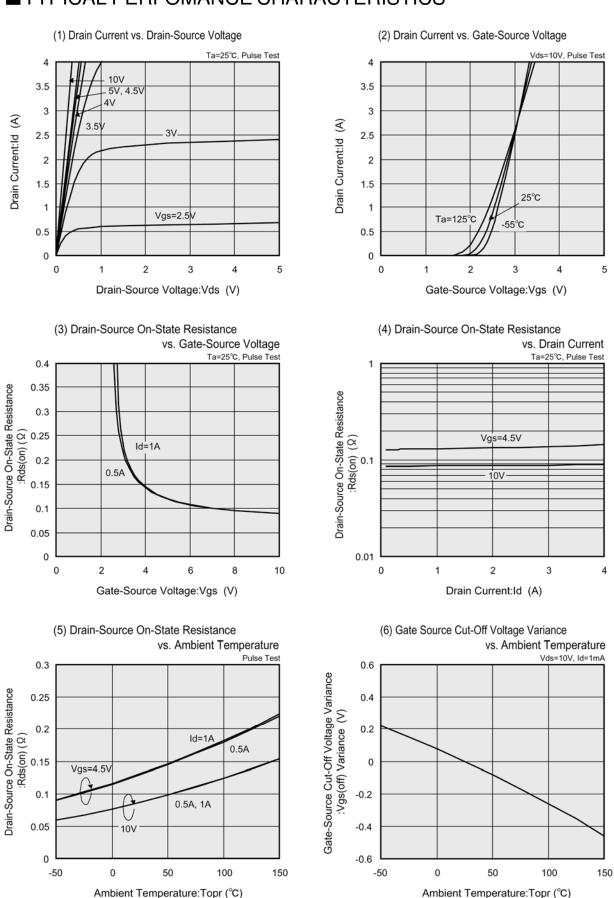
Switching Characteristics

Switching Characteristics					Т	a = 25°C
PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)		-	10	-	ns
Rise Time	tr	Vgs= 5V, Id= 0.5A Vdd= 10V	-	15	-	ns
Turn-Off Delay Time	td (off)		-	25	-	ns
Fall Time	tf		-	45	-	ns

Thermal Characteristics

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal Resistance (Channel-Ambience)	Rth (ch-a)	Implement on a ceramic PCB	-	250	-	°C/W

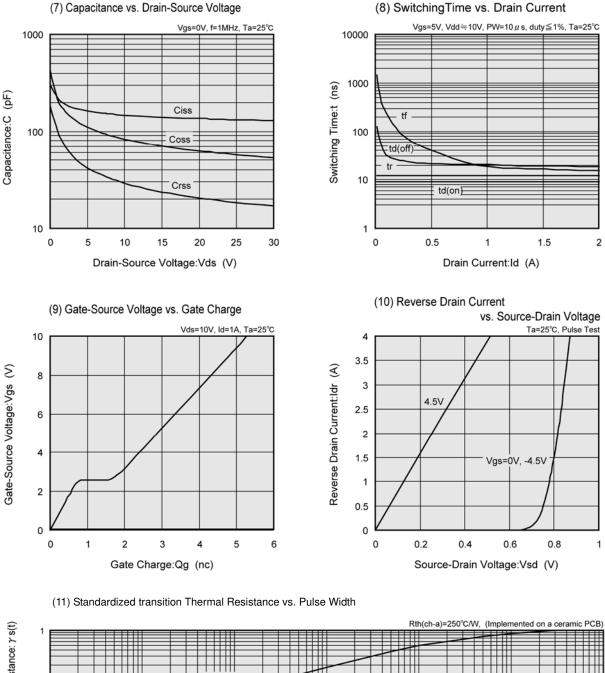
Та	=	25°C
ıα	_	200

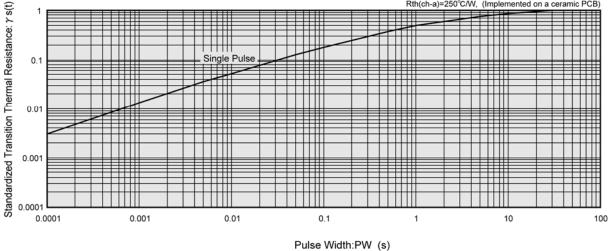


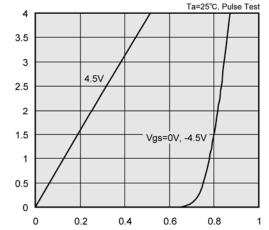
■TYPICAL PERFOMANCE CHARACTERISTICS

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■TYPICAL PERFOMANCE CHARACTERISTICS (Continued)







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